(Unclassified version with commercially sensitive or confidential information and Members' names removed)

BDC 6/2024

Minutes of the 83rd Meeting of the Business Development Committee of the Hong Kong Productivity Council held at 3:00p.m. on Tuesday, 5 March 2024 in Boardroom, 2nd Floor, HKPC Building, 78 Tat Chee Avenue, Yau Yat Chuen, Kowloon

Present: Chairman – Mr. Bryant Chan Wan-sing

Members – Mr. Mohamed D. Butt, MH

Prof. Viveca Chan E-nam*

Ms. Clara Chan Yuen-shan, MH

Mr. Anthony Lam Sai-ho*
Prof. Matthew Lee Kwok-on
Mr. Indiana Wong Man abund

Mr. Indiana Wong Man-chung

(Assistant Commissioner for Innovation and Technology (Funding Schemes), representing Mr. Ivan Lee, JP, Commissioner for

Innovation and Technology)* Mr. Emil Yu Chen-on, BBS, JP

In Attendance from Innovation and Technology Commission:

Mr. Jacky Chow Chi-hang* Manager (Innovation and Technology Fund)

In Attendance from HKPC:

Dr. Lawrence Cheung Chief Innovation Officer
Mr. Edmond Lai Chief Digital Officer
Ms. Vivian Lin Chief Operating Officer

Mr. Brian Wong Chief People and Culture Officer

Ms. Christina Cheung
Ms. Gillian Luk
Ms. Olivia Poon

Chief Financial Officer
Head, Council Secretariat
Manager, Council Secretariat

^{*}attendance via Microsoft Teams application

Welcome to New Chairman

Mr. Mohamed D. Butt, Executive Director (ED) welcomed Mr. Bryant Chan Wan-sing as the new Chairman of the Business Development Committee (BDC). The Chairman thanked ED for the welcome and asked for Members' continued support to the BDC.

Mode of Meeting

The Chairman said that the meeting was held in person with 3 Members joining via Microsoft Teams. He thanked Members for attending the meeting.

Welcome to New Members

The Chairman welcomed Prof. Viveca Chan E-nam and Mr. Anthony Lam Sai-ho who attended the meeting for the first time.

Vote of Appreciation

<u>The Chairman</u> suggested, and <u>Members</u> agreed, to record a vote of appreciation to Mr. Ricky Chan Wai-chung and Ir Paul Poon Wai-yin for their contributions during their respective tenure as Chairman and Member of the BDC.

Declaration of Interest

<u>The Chairman</u> reminded Members to declare interest should they observe any direct/pecuniary interest in any matter to be discussed at the meeting.

I. <u>Confirmation of Minutes</u> (BDC 20/2023)

1. The Draft Minutes of the 82nd BDC meeting held on 14 November 2023 had been circulated to Members and there were no requests for amendments. The Minutes of the meeting were taken as read, confirmed and signed by the Chairman.

II. Consultancy Study on Mainland Expansion and Plan for Executing Study Recommendations (BDC 1/2024)

- 2. Invited by the Chairman, briefed Members on the recommendations of a consultancy study on HKPC's Mainland expansion.
- 11. After discussion, <u>Members</u> supported the study recommendations and execution plan as detailed in the paper for the Council's consideration.

III. Annual Report on Special Project "SME ReachOut" for 2023 (BDC 2/2024)

- 12. <u>Members</u> received a presentation by on the annual report of the SME ReachOut special project for 2023.
- 16. Members noted the report on the SME ReachOut project for 2023.

IV. 2024/25 Annual Plan and 2023/24 Annual Report of Automotive Platforms and Application Systems R&D Centre (BDC 3/2024)

- 17. <u>Members</u> noted a presentation by on the 2024/25 Annual Plan and 2023/24 Annual Report of the Automotive Platforms and Application Systems R&D Centre (APAS) for submission to the Innovation and Technology Commission (ITC), in line with the funding agreement with the Government for APAS.
- 22. <u>Members</u> noted the 2024/25 Annual Plan and 2023/24 Annual Report of APAS.

V. Report on Proposals for Government Funding Schemes (April 2023 – January 2024) (BDC 4/2024)

- 23. <u>Members</u> noted report that between April 2023 and January 2024, 41 proposals with HKPC's involvement were approved for HK\$90.9M and RMB7.5M under Government funding schemes as follows:
- (a) Innovation and Technology Fund (ITF): 20 approved projects for HK\$44.5M;
- (b) Trade and Industrial Organisation Support Fund (TSF): 16 approved projects for HK\$32.9M;
- (c) Environment Conservation Fund (ECF): 3 approved projects for HK\$13.5M;
- (d) 深港澳科技計劃項目(C類項目): 1 approved project for RMB2.6M; and
- (e) 科技部國家重點研發計劃: 1 approved project for RMB4.9M.

VI. <u>Final Performance Review of Completed Innovation and Technology Fund (ITF) Projects</u> (BDC 5/2024)

- 24. <u>Members</u> noted the final performance review of 9 completed ITF projects, as follows:
- (a) Development of Real-time Crack Detection System for Buildings Using Unmanned Aerial Vehicle;
- (b) Development of a Maintenance-free and Self-energised Industrial Wireless Sensor (MSIWS);
- (c) Development on Testing Algorithms and Advanced Development Toolkits for Smart Wearables and Hybrid/Traditional Watches;
- (d) Trial: Thermal Comfort, Light Weight and Recyclable Bedding Products Made from Air Splitting Technology;
- (e) Development of Severe Plastic Deformation (SPD) and Sheet Stamping Technologies for Customerised Engineering High Entropy Alloy (HEA) Auto Parts Manufacturing;
- (f) R&D of Advanced AI Imaging System for Adverse Atmospheric Conditions for Autonomous Driving;
- (g) R&D of a 28-seat Low-Entry and Lightweight Full Electric Minibus with AI-Enhanced ADAS and Geofencing Systems;
- (h) Development of CME Flexible Metallic Fiber Physical Porous Part Fabrication Process and Machine Tools Retrofit Mechanism for 3D Lightweight and Thermal Management Auto Parts Production; and
- (i) Hong Kong Tech Challenge Game 2022.

VII. Any Other Business

(A) Measures in Support of 2024/25 Budget of Government

- 25. <u>Members</u> noted the measures by HKPC to support the measures announced by the Government in the Budget for 2024/25, as presented by and as follows:
- (a) enhancing Belt and Road collaboration in the areas of green technology, talent attraction and technology exchange;
- (b) setting up a World Intellectual Property Organisation (WIPO) Technology and Innovation Support Centre in Hong Kong to support innovation and technology development through promotion of patent knowledge and intellectual property trading; and
- (c) implementing new measures under Government funding schemes. These would include riding on the \$500M injection to the Dedicated Fund on Branding, Upgrading, and Domestic Sales (BUD Fund) to enhance SMEs' competitiveness and support their expansion into Mainland and overseas markets. In addition, "E-commerce Easy" would be launched under the BUD Fund to support enterprises to implement e-commerce projects in the Mainland. There was also enhancement under the Pilot Subsidy Scheme for Third-party Logistics Service Providers, including lifting the funding ceiling to \$2M per enterprise and expanding the funding scope to cover services related to the application of ESG technology solutions.

(B) Update on Government Funding Schemes Secretariat Service

26. <u>Members</u> note the update by on HKPC's involvement in Government funding schemes.

(C) <u>Update on Hong Kong Industrial Artificial Intelligence & Robotics Centre (FLAIR)</u>

28. <u>Members</u> noted the update by on the latest developments of FLAIR in terms of commercialisation progress, promotion, centre operation and senior staff movement.

(E) Key Performance Indicators Performance in 2023/24

30. <u>Members</u> noted the update by on HKPC's performance in the first 10 months of 2023/24 along the 19 Key Performance Indicators (KPI) targets.

(G) Appointment of Mentor for ITF Project

35. <u>Members</u> agreed to appoint as the mentor of a new ITF project commenced in January 2024, namely "Development of Ionic Liquid Electroforming Process to Produce Platinum Electroform with Exquisite and Brilliant Surface for Jewellery Industry".

(H) Attendance Record

36. <u>Members</u> noted their attendance record for 2023 as circulated together with the meeting agenda and papers by email on 27 February 2024 and shown at the meeting. <u>The Chairman</u> reminded Members to try their best to attend future meetings.

VIII. Date of Next Meeting

- 37. <u>Members</u> noted that the next meeting would tentatively be held on 2 July 2024 at 3:00 pm.
- 38. There being no other business, the meeting was closed at 4:45 pm.